

FMMT722

70V PNP SILICON LOW SATURATION TRANSISTOR IN SOT23

Features

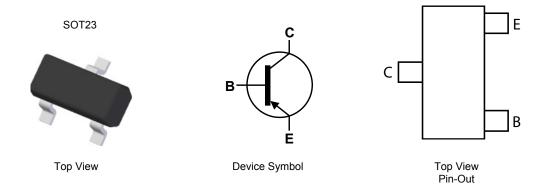
- BV_{CEO} > -70V
- I_C = -1.5A Continuous Collector Current
- I_{CM} = -3A Peak Pulse Current
- Low Saturation Voltage V_{CE(sat)} < -220mV @ -1A
- $R_{CE(SAT)} = 140 \text{m}\Omega$ for a low equivalent on-resistance
- 625mW power dissipation
- h_{FE} characterised up to -3A for high current gain hold-up
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: molded plastic, "Green" molding compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight 0.008 grams (approximate)

Applications

- High-side driver
- Load disconnect switch
- Motor drive



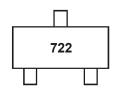
Ordering Information (Note 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FMMT722TA	AEC-Q101	722	7	8	3,000
FMMT722QTA	Automotive	722	7	8	3.000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.
- 5. For packaging details, go to our website at http://www.diodes.com

Marking Information



722 = Product Type Marking Code



FMMT722

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-70	V
Collector-Emitter Voltage	V_{CEO}	-70	V
Emitter-Base Voltage	V_{EBO}	-7	V
Continuous Collector Current	I _C	-1.5	Α
Peak Pulse Current	I _{CM}	-3	Α
Base Current	I _B	-500	mA

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	625	mW
Power Dissipation (Note 7)	P _D	806	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta JA}$	200	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	$R_{\theta JA}$	155	°C/W
Thermal Resistance, Junction to Leads (Note 8)	R _{0JL}	194	°C/W
Operating and Storage Temperature Range	$T_{J,}T_{STG}$	-55 to +150	°C

ESD Ratings (Note 9)

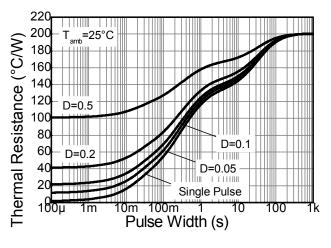
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	С

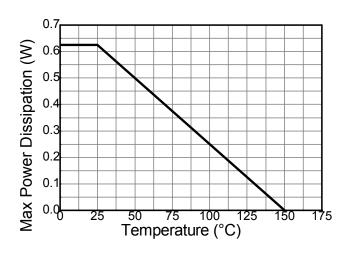
Notes:

- 6. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- Same as note 6, except the device is measured at t ≤ 5 sec.
- 8. Thermal resistance from junction to solder-point (at the end of the collector lead).
- 9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

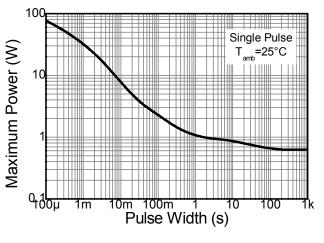


Thermal Characteristics and Derating information



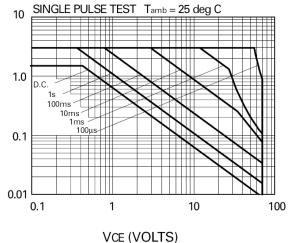


Transient Thermal Impedance



Pulse Power Dissipation





Safe Operating Area

Ic (AMPS)



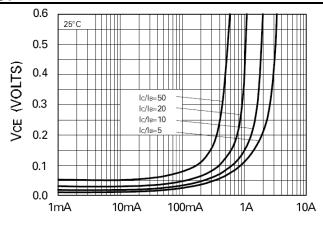
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_CBO	-70	-150	-	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-70	-125	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV_EBO	-7	-8.8	-	V	I _E = -100μA
Collector Cutoff Current	I _{CBO}	-	<1	-100	nA	V _{CB} = -60V
Emitter Cutoff Current	I _{EBO}	-	<1	-100	nA	V _{EB} = -5.6V
Collector Emitter Cutoff Current	I _{CES}	-	<1	-100	nA	V _{CE} = -60V
		300	470	-		$I_C = -10 \text{mA}, V_{CE} = -5 \text{V}$
		300	450	-	-	$I_C = -0.1A$, $V_{CE} = -5V$
Static Forward Current Transfer Ratio (Note 10)	h_{FE}	175	275	-		$I_C = -1A, V_{CE} = -5V$
		40	60	-		I _C = -1.5A, V _{CE} = -5V
		-	10	-		$I_C = -3A$, $V_{CE} = -5V$
	V _{CE(sat)}	-	-35	-50	- mV	I _C =- 0.1A, I _B = -10mA
Collector Emitter Seturation Voltage (Note 10)		-	-135	-200		$I_C = -0.5A$, $I_B = -20mA$
Collector-Emitter Saturation Voltage (Note 10)		-	-140	-220		$I_C = -1A$, $I_B = -100mA$
		-	-175	-260		$I_C = -1.5A$, $I_B = -200mA$
Base-Emitter Turn-On Voltage(Note 10)	$V_{BE(on)}$	-	-0.78	-1.0	V	I _C = -1.5A, V _{CE} = -5V
Base-Emitter Saturation Voltage(Note 10)	$V_{BE(sat)}$	-	-0.94	-1.05	V	$I_C = -1.5A$, $I_B = -200mA$
Output Capacitance	C_{obo}	-	14	20	pF	V _{CB} = -10V, f = 1MHz
Transition Frequency	f _T	150	200	-	MHz	$V_{CE} = -10V, I_{C} = -50mA,$ f = 100MHz
Turn-On Time	t _{on}	-	40	-	ns	$V_{CC} = -50V, I_{C} = -0.5A$
Turn-Off Time	t _{off}	-	700	-	ns	$I_{B1} = I_{B2} = -50 \text{mA}$

Notes: 10. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%



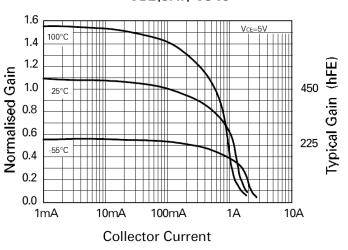
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



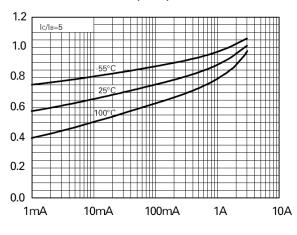
Collector Current

Collector Current

VBE(SAT) vs IC

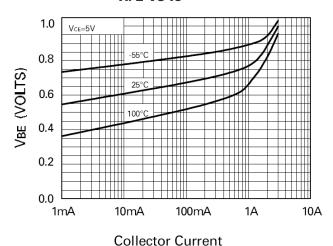






Collector Current

hfe vs lc



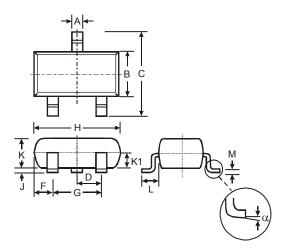
VBE(SAT) vs IC

VBE (VOLTS)



Package Outline Dimensions

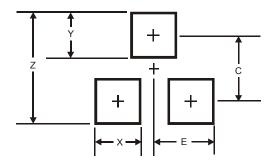
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Η	2.80	3.00	2.90		
7	0.013	0.10	0.05		
K	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	8.0
Y	0.9
С	2.0
Е	1.35





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